

Driver IC for 3-phase Brushless Motor

KA44143A Datasheet

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Regarding the specifications of this product, it is considered that you have agreed to the quality level and disclaimer described below.

Support for industry standards and quality standards

Functional safety standards for automobiles ISO26262	Νο
AEC-Q100	Νο
Market failure rate	50Fit

Disclaimer

- When the application system is designed using this IC, please design the system at your own risk. Please read, consider, and apply appropriate usage notes and description in this standard.
 When designing your application system, please take into the consideration of break down and failure mode occurrence and possibility in semiconductor products. Measures on the systems such as, but not limited to, redundant design, mitigating the spread of fire, or preventing glitch, are recommended in order to prevent physical injury, fire, social damages, etc. in using the Nuvoton Technology Japan Corporation (hereinafter referred to as NTCJ) products.
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 - 9. In case of damages, costs, losses, and/or liabilities incurred by NTCJ arising from customer's noncompliance with above from 1 to 8, customer will indemnify NTCJ against every damages, costs, losses and responsibility.

FEATURES

- Supply voltage range: 4.5 V ~ 26.4 V
- Built-in 5-V regulator
- 3-phase full-wave sine-wave PWM drive by 1-Hall-sensor
- Selectable Input Mode: Either linear voltage input or PWM input through VSP pin
- Selectable the start frequency through SWSF pin
- Conduction angle auto driver phase shift correction
- Rotation direction selectable (Forward/Reverse)
- FG pulse divide selectable
- Sleep mode
- Various protection functions: Under Voltage Lock Out (UVLO), Over Voltage Lock Out (OVLO), Thermal protection, Over Load Protection, and Over Current Protection
- •Package QFN 24L (4x4x0.8mm3, Lead Pitch 0.5mm)

DESCRIPTION

• KA44143A is a driver IC for 3-phase brushless motor optimized for fan motors.

By employing the rotor position detector and sine wave PWM drive by 1-Hall-sensor, this IC achieves component reduction and miniaturization of motor set as well as motor drive at low noise, low vibration and low power consumption.

APPLICATIONS

• Refrigerator, Projector, Printer, Factory automation





Notes: The application circuit is an example. The operation of the mass production set is not guaranteed. Sufficient evaluation and verification is required in the design of the mass production set. The Customer is fully responsible for the incorporation of the above illustrated application circuit in the design of the equipment.

Motor drive waveform

KA44143A 3-phase full-wave sine-wave PWM drive



 $V_{CC} = 12 \text{ V}, \text{ V}_{FR} = 0 \text{ V}, \text{ V}_{VSP} = \text{PWM mode (60kHz,Duty60\%)}$





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ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rating	Unit	Notes
Supply voltage	V _{cc}	28	V	*1
Operating ambient temperature	T _{opr}	$-$ 40 \sim + 105	°C	*2
Storage temperature	T _{stg}	– 55 \sim +150	°C	*2
	V _{VREG}	$-0.3 \sim 6.0$	V	*3
Input Voltage Range	V _{SLEEP} , V _{H1H} , V _{H1L} , V _{FGSEL} , V _{VSP} , V _{SFSW} , V _{FR} , V _{RDS} , V _{PS} , V _{OVS}	$-0.3 \sim 6.0$	V	_
	V _{TRI} ,V _{SST}	$-0.3 \sim 6.0$	V	_
	V_{FG}, V_{RD}	$-0.3 \sim 6.0$	V	_
	V _{VREG}	$-0.3 \sim 6.0$	V	_
Output Voltage Range	V _{RCS}	$-0.3 \sim 6.0$	V	*4
	V _{BC1}	28	V	*4
	V_{BC2}, V_{pump}	37	V	*4
	I _{Upeak} , I _{Vpeak} , I _{Wpeak}	± 2200	mA	*5, *6
Output Current Range	I _{FG} ,I _{RD}	5	mA	_
	I _{VREG}	-10	mA	_
ESD	HBM	2	kV	_

Notes: This product may sustain permanent damage if subjected to conditions higher than the above stated absolute maximum rating. This rating is the maximum rating and device operating at this range is not guaranteed as it is higher than our stated recommended operating range. When subjected under the absolute maximum rating for a long time, the reliability of the product may be affected.

- *1:The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.
- *2: Except for the power dissipation, operating ambient temperature, and storage temperature, all ratings are for Ta = 25°C. *3: Applying external voltage to this pin is possible only when this pin and VCC pin is connected.
- When applying external voltage to this pin, do not exceed the stated ratings even in transient state.
- *4: Applying external voltage into these pins is prohibited. Do not exceed the stated ratings even in transient state.
- *5: Applying external voltage into these pins is prohibited. Do not exceed the stated ratings even in transient state.
- *6: For VCC ≥ 5.6 V, output current is ±2200 mA. For VCC < 5.6 V, output current is ±1500 mA. Please ensure that there is enough margin and the design does not exceed the allowable value of Power Dissipation(P_D) and Area of Safe Operation(ASO).

POWER DISSIPATION RATING

Package	θ _{j-a}	θ _{j-c}	Р _D (T _a =25 °С)	Р _D (T _a =105 °С)
QFN 24L (4x4x0.8mm3, Lead Pitch 0.5mm)	56.1 °C/W	4.4 °C/W	2.22 W	0.80 W

Notes: For the actual usage, follow the power supply voltage, load and ambient temperature conditions to ensure that there is enough margin and the thermal design does not exceed the allowable value.

Glass-Epoxy Substrate (2 Layers) : 50 x 50 x 0.8t (mm), Heat dissipation fin: Die-pad, Soldered. (Heat dissipation via 2 layer board)



CAUTION

Although this IC has built-in ESD protection circuit, it may still sustain permanent damage if not handled properly. Therefore, proper ESD precautions are recommended to avoid electrostatic damage to the MOS gates.

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min.	Тур.	Max.	Unit	Notes
Supply voltage range	V _{cc}	4.5	_	26.4	V	_
	V _{SLEEP}	0		V _{VREG}	V	*1
	V _{H1H}	0	_	V _{VREG}	V	*1
	V _{H1L}	0	_	V _{VREG}	V	*1
	V _{PS}	0	_	V _{VREG}	V	*1
	V _{RDS}	0	_	V _{VREG}	V	*1
Input voltage range	V _{OVS}	0	_	V _{VREG}	V	*1
	V _{FGSEL}	0	_	V_{VREG}	V	*1
	V _{VSP}	0	_	V _{VREG}	V	*1
	V _{SFSW}	0	_	V_{VREG}	V	*1
	V _{FR}	0		V_{VREG}	V	*1
	C _{VCC}	4.7μ			F	*2,*3
	C _{VCC1}		0.1µ		F	*2,*3
	C_{VREG}		0.1μ		F	*2,*4
	C _{SST}	22p	1800p	_	F	*2,*5
	C _{BC}	_	0.1µ	_	F	*2,*4
External constants	C _{VPUMP}		0.1µ		F	*2,*4
	C _{TRI}	220p	390p	1300p	F	*2,*5
	R _{RCS}	0.15	0.22		Ω	*2,*5,*6
	R _{VH}		1k	_	Ω	*2,*5
	C _{FGSEL}		0.01µ		F	*2,*7
	C _{VSP}		0.1µ		F	*2,*8

Note: *1: For setting range of input control voltage, refer to Electrical Characteristics (page 7 - 10) and Operation (page 13 - 35).

*2: Operation of mass production set is not guaranteed. Perform enough evaluation and verification on the design of mass production set.

*3: Please perform sufficient evaluation and verification to ensure that VCC pin voltage ripple is reduced.

- *4: It is recommended to use the values indicated.
- *5: Please choose the setting according to the usage. Please refer to the Electrical Characteristics (page 7 10) and Operation (page 13 35).

*6: Do not use resistor of value smaller than this. When using value smaller than the minimum value, latch-up function which is used to prevent thermal damage may operate due to external factors (PCB heat dissipation, metal impedance, etc...) or internal factors (threshold change, etc...).

*7: When using with FGSEL pin open, please connect capacitor to the FGSEL pin to prevent noise and carry out sufficient evaluation and verification.

*8: When VSP pin is used for DC input, it is recommended to insert a capacitor to the VSP pin.

ELECTRICAL CHARACTERISTICS

 V_{CC} = 12.0 V, V_{VREG} = 5.0 V

Note: $T_a = 25^{\circ}C \pm 2^{\circ}C$ unless otherwise noted.

Parameter		Symbol Condition			Limits		Unit	Noto
	Farameter		Condition	Min	Тур	Max	Unit	Note
Cir	cuit Current		1					
	V _{CC} current	I _{CC1}	_	3.0	5.6	9.0	mA	—
	V_{CC} current at sleep mode	I _{CC3}	V _{SLEEP} = H	—	—	50	μA	—
Re	gulator Block							
	VREG voltage	V_{VREG}	_	4.7	5	5.3	V	—
	Output impedance	Z _{VREG}	$I_{VREG} = -10 \text{ mA}$	—	—	10	Ω	—
FG	Block						-	
	FG output (low voltage)	V_{FGL}	I _{FG} = 1.0 mA	_	0.1	0.3	V	—
RD	Block							
	RD output (low voltage)	V _{RDL}	I _{RD} = 1.0 mA	_	0.1	0.3	V	_
Po	ver Block	-						
	On resistance	R _{ONHL}	I = 400 mA	0.5	1.0	1.5	Ω	_
	On resistance (Vcc=4.5V)	R _{ONHL}	Vcc = 4.5V I = 400 mA	_	1.25	2.05	Ω	
	Diode forward voltage	V _{DI}	l = 400 mA	0.6	0.8	1	V	—
Мо	tor Lock Protection			-				
	Lock detection time_LL	t _{LOCK1_LL}	RDS, SFSW = L,L	0.35	0.5	0.65	s	—
	Lock release time_LL	t _{LOCK2_LL}	RDS, SFSW = L,L	3.5	5	6.5	s	_
	Lock protection ratio_LL	PR _{RATIO_LL}	RDS, SFSW = L,L	9	10	11	_	_
	Lock detection time_LH	t _{LOCK1_LH}	RDS, SFSW = L,H	0.7	1	1.3	s	_
	Lock release time_LH	t _{LOCK2_LH}	RDS, SFSW = L,H	7	10	13	s	—
	Lock protection ratio_LH	PR _{RATIO_LH}	RDS, SFSW = L,H	9	10	11	_	_
	Lock detection time_HL	t _{LOCK1_HL}	RDS, SFSW = H,L	1.4	2	2.6	s	*1
	Lock detection time_HH	t _{LOCK1_HH}	RDS, SFSW = H,H	0.35	0.5	0.65	s	*2
Ove	er Current Protection							
	Over current detection level	V _{CL1}	_	0.225	0.250	0.275	V	_
SLI	EEP							
	Low-level input voltage	V _{SLL}	_	_	_	0.5	V	_
	High-level input voltage	V _{SLH}	_	2.5	_	_	V	_
	Open-circuit voltage	V _{SLZ}	_	_	0	0.3	V	_
	Input impedance	Z _{SL}	_	70	100	130	kΩ	_
Inte	ernal Oscillation Frequency	5		1				
L	Internal oscillation frequency	f _{osc}	_	17.5	25	32.5	MHz	_

Note: *1:Motor Lock Protection is released immediately by UVLO signal input and SLEEP signal input.

*2: Motor Lock Protection automatically resets immediately(after 70us elapses).

ELECTRICAL CHARACTERISTICS (Continued)

 V_{CC} = 12.0 V, V_{VREG} = 5.0 V

Note: $T_a = 25^{\circ}C \pm 2^{\circ}C$ unless otherwise noted.

	Parameter	Symbol Condition			Limits	nits		Note
	Farameter	Symbol	Condition	Min	Тур	Max	Unit	Note
vs	P		•					
	Pin current	I _{VSP}	V _{VSP} =5.0V	—	15	45	μA	—
vs	P DC Input Control							
	Stop control VSP input	V _{VSPDCL}	—	0.9	1.0	1.1	V	—
	Max. speed VSP input	V _{VSPDCH}	—	3.6	4.0	4.4	V	—
vs	P PWM Input Control		•					
	Stop control VSP input	V _{VSPPWML}	V _{VREG} =V _{TRI} =5.0V	2	3	4	%	*1,*2
	Max. speed VSP input	V _{VSPPWMH}	V _{VREG} =V _{TRI} =5.0V	_	100	_	%	*1,*4
	Low-level input voltage during PWM input	V _{VSPLL}	V _{VREG} =V _{TRI} =5.0V	-	1	1.0	V	*1
	High-level input voltage during PWM input	V _{VSPHL}	V _{VREG} =V _{TRI} =5.0V	2.0	_	_	V	*1
	PWM input frequency range	F _{PWM}	-	15	_	100	kHz	*1
Tri	angle Wave Oscillator for PWM Wav	eform (TRI	pin)				-	
	Amplitude	V _{TRI}	—	1.36	1.53	1.70	Vpp	—
	External capacitor charging current	I _{TRI1}	V _{TRI} =0.5V	-83.5	-64.5	-45.5	μA	—
	External capacitor discharging current	I _{TRI2}	V _{TRI} =2.0V	45.5	64.5	83.5	μΑ	—
	TRI pin input voltage during PWM control	V _{TRITH}	—	2.9	_	_	V	*1
Tri	angle Wave Oscillator during Soft S	tart (SST pi	n)					
	Amplitude	V _{SST}	—	0.75	1.0	1.25	Vpp	—
	External capacitor charging current	I _{SST1}	V _{SST} =0.6V	-6.0	-4.0	-2.0	μA	—
	External capacitor discharging current	I _{SST2}	V _{SST} =1.6V	2.0	4.0	6.0	μA	_
	SST pin input voltage when Soft Start not used	V _{SSTTH}	_	2.9	_	_	V	*3
На	l Block							
	Input dynamic range	V _{HALL}	_	0	_	VREG -2.0V	V	_
	Pin current	I _{HALL}	_	- 2	0	2	μA	—
	Input offset voltage for H1H-H1L drop	V _{HOFS}	_	-6	0	6	mV	_
	Min. input amplitude voltage	V _{HA}	_	25	_	_	mV	—
	Hysteresis width	V _{HHYS}	_	7.5	10	13	mV	

Note: *1: During PWM control setting, TRI pin must be connected to VREG pin.

*2: It is recommended to input 0% Duty (Low input) when input STOP.

*3: When Soft Start is not in used, SST pin must be connected to VREG pin.

*4: Typical Design Value.

ELECTRICAL CHARACTERISTICS (Continued)

 V_{CC} = 12.0 V, V_{VREG} = 5.0 V

Note: $T_a = 25^{\circ}C \pm 2^{\circ}C$ unless otherwise noted.

	Parameter	Symbol	Symbol Condition		Limits		Unit	Note
	i arameter	Gymbol	Condition	Min	Тур	Max		Note
FR	(3-State Input circuit)							
	Low-level input voltage	V _{FRL}	_			0.8	V	—
	Mid-level input voltage	V_{FRM}	_	1.3	—	2.0	V	—
	High-level input voltage	V_{FRH}	_	2.5	—	_	V	—
	Open-circuit voltage	V_{FRZ}	—	1.4	1.65	1.9	V	—
	Pin current	I _{INFR}	V _{FR} = 0 V	- 40	- 20		μA	—
FG	SEL (3-State Input circuit)							
	Low-level input voltage	V _{FGSELL}	—	_	_	1.0	V	—
	High-level input voltage	V _{FGSELH}	—	4.0	_	_	V	*1
	Open-circuit voltage	V _{FGSELZ}	—	1.8	2.4	2.8	V	*2
	Pin current	I _{INFG}	V _{FGSEL} = 0 V	- 40	- 20	_	μA	—
PS	(2-State Input circuit)							
	Low-level input voltage	V _{PSL}	_	_	_	1.0	V	—
	High-level input voltage	V _{PSH}	—	4.0	_	_	V	*1
	Open-circuit voltage	V _{PSZ}	—		0.0	0.5	V	—
	Pin current	I _{INPS}	V _{PS} = 5.0 V	_	5	15	μA	—
RD	S (2-State Input circuit)		•					
	Low-level input voltage	V _{RDSL}	_	_	_	1.0	V	—
	High-level input voltage	V _{RDSH}	_	4.0	_	_	V	*1
	Open-circuit voltage	V _{RDSZ}	—	_	0.0	0.5	V	—
	Pin current	I _{INRDS}	V _{RDS} = 5.0 V	_	5	15	μA	—
ov	S (2-State Input circuit)		•	•			•	•
	Low-level input voltage	V _{OVSL}	_	_	_	1.0	V	—
	High-level input voltage	V _{OVSH}	_	4.0	_		V	*1
	Open-circuit voltage	V _{ovsz}	_	_	0.0	0.5	V	_
	Pin current	I _{INOVS}	V _{OVS} = 5.0 V	_	5	15	μA	_
SF	SW (2-State Input circuit)							
	Low-level input voltage	V _{SFSWL}	_	_	_	1.0	V	_
	High-level input voltage	V _{SFSWH}	_	4.0	_	_	V	*1
	Open-circuit voltage	V _{SFSWZ}	_	_	0.0	0.5	V	_
	Pin current	I _{INSFSW}	V _{SFSW} = 5.0 V	—	5	15	μA	—

Note: *1: During High level setting, please ensure to connect to VREG pin.

*2: Please connect a capacitor to FGSEL pin when it is open during use to prevent noise. To ensure the noise prevention, please perform sufficient evaluation and verification.

ELECTRICAL CHARACTERISTICS (Continued)

 $V_{CC} = 12.0 \text{ V}, V_{VREG} = 5.0 \text{ V}$

Note: $T_a = 25^{\circ}C \pm 2^{\circ}C$ unless otherwise noted.

	Paramotor	Symbol Condition		De	esign value		Unit	Noto
		Symbol	Condition	Min	Тур	Max	Unit	Note
Th	ermal Protection							
	Protection operating temperature	TSD _{ON}	—	_	160	—	°C	*1*2
	Hysteresis width	TSD _{HYS}	_	_	25	_	°C	*1*2
Ou	tput Block					•		
	Output rising slew rate at source current	V _{TRSO}	_	_	300	_	V/µs	*1*2
	Output falling slew rate at source current	V _{TFSO}	_	_	300	_	V/µs	*1*2
	Output rising slew rate at sink current	V _{TRSI}	—	_	300	_	V/µs	*1*2
	Output falling slew rate at sink current	V _{TFSI}	—	_	300	_	V/µs	*1*2
Tri	angle Wave Oscillator for PWM Wav	eform (TRI	pin)					
	Oscillation frequency range	f _{TRI}	—	15	_	100	kHz	*2
	Standard oscillation frequency	F _{TRI}	C _{TRI} = 390 pF	—	55.4		kHz	*1*2
Tri	angle Wave Oscillator during Soft S	tart (SST pi	n)					
	Standard oscillation frequency	F _{SST}	C _{SST} = 1800 pF	_	1.13	—	kHz	*1*2
Ма	ximum Rotating Speed							
	Minimum hall cycle	T _{HMIN}	—	_	173	_	μS	*1*2
Un	der Voltage Lock Out							
	Protection operating voltage	V _{LVON}	_	_	3.55	_	V	*1*2
	Protection release voltage	V _{LVOFF}	_	_	3.75		V	*1*2
οv	er Voltage Lock Out							
	Protection operating voltage 1	V _{OVON1}	V _{OVS} = VREG	15.0	16.0	17.0	V	*2
	Protection operating voltage 2	V _{OVON2}	$V_{OVS} = 0V$	26.4	27.2	28.0	V	*2

Note: *1: Typical Design Value.

*2: These are values checked by design but not production tested.





PIN FUNCTIONS

Pin No.	Pin name	Туре	Description			
1	RD	Output	Over load protection			
2	FG	Output	FG external output			
3	SLEEP	Input	Sleep setting			
4	VREG	Output	Internal reference voltage			
5	GND	Ground	Ground			
6	VPUMP	Output	Charge pump circuit output			
7	VCC	Power	Supply voltage for motor			
8	W	Output	W-phase output			
9	RCS	Output	Motor current detector			
10	V	Output	V-phase output			
11	U	Output	U-phase output			
12	BC2	Output	Capacitor connection pin 2 for charge pump			
13	BC1	Output	Capacitor connection pin 1 for charge pump			
14	OVS	Input	Over voltage detection selectable threshold. High for 16V detection, Low for 27.2V detection			
15	RDS	Input	Selectable Release of Motor lock protection. High to use the release of lock protection. Low to disable the release of lock protection.			
16	PS	Input	Selectable phase shift mode. High to enable constant phase shift mode. Low to enable Auto Phase FB shift mode.			
17	FGSEL	Input	FG pulse count select			
18	SST	Input / Output	Capacitor connection pin for Soft Start triangle wave oscillator frequency setting			
19	TRI	Input / Output	Capacitor connection pin for PWM triangle wave oscillator frequency setting			
20	H1H	Input	Hall amplifier input (+)			
21	H1L	Input	Hall amplifier input (-)			
22	FR	Input	Rotation direction select (Forward/Reverse)			
23	SFSW	Input	Selectable the start frequency			
24	VSP	Input	Voltage input for setting rotating speed			



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FUNCTIONAL BLOCK DIAGRAM



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OPERATION

Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

1. VSP input configuration

1-1. PWM input mode

PWM input control or DC input control are used as the input controls to VSP pin. When using PWM input control, please ensure to connect TRI pin to VREG pin. Peak value of average output voltage is determined, corresponding to PWM duty signal.



Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

1. VSP input configuration (Continued)

1-2. VSP input mode

PWM input control or DC input control are used as the input controls to VSP pin. When using DC input control, please ensure to connect a capacitor between TRI pin and GND pin.



Signal during DC input mode

During DC input mode, PWM signal is generated by the comparison between the TRI pin triangle waveform and the VSP pin input DC voltage.

Peak value of average output voltage is dependent on VSP pin voltage and output PWM frequency is dependent on TRI pin triangle waveform frequency.

TRI pin triangle wave oscillator frequency

The triangle wave oscillator frequency input into TRI pin is calculated using the below formula.



Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

2. VSP input voltage and average output voltage



OAverage Output Voltage of motor



Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

3. Hall Input Specification

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3-1. System to detect hall signal

The motor position is detected by the Hall hysteresis comparator. If the amplitude of sine wave is small, phase delay of comparator output will be very prominent. Therefore, please make the amplitude of the sine wave larger. Recommendation is 200 mV or more. When chattering occurs to Hall element, insert a capacitor between H1H (pin 20) and H1L (pin 21).



For the biased source of the Hall element, please construct by externally shorting to VREG pin.



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Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

3. Hall Input Specification (Continued)

3-2. The Relation between Hall Voltage and FGSEL

1-cycle FG signal, which is equivalent to 1-cycle/2-cycle/3-cycle of Hall sine wave (selected by FGSEL), is output.



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Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

3. Hall Input Specification (Continued)

3-3. Drive Phase Shift Control

Automatic drive phase shift control when PS=Low. The hall signal phase with respect to the conduction angle detects the IC's own phase difference and automatically correct it to the most optimum phase. The example for U-phase output voltage is shown below.

Automatic drive phase shift control when PS=Low



Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

3. Hall Input Specification (Continued)

3-4. Hall Sensor Placement

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This IC uses only 1 hall sensor. Please put Hall sensor at the center between U and W stator coils.

The diagram below shows the hall placement for a 2 pole 3 slots motor



Example placement for the hall sensor (2 pole 3 slot motor)

Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

4. Start / Stop control

Start-up by rising VCC pin voltage



•During start up mode, no FG signal is output.

Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

4. Start / Stop control (Continued)

Start-up by SLEEP signal release



•During start up mode, no FG signal is output.

Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

4. Start / Stop control (Continued)

Start-up sequence

The waveform during start up is shown by below figure.



Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

5. Soft Start Function and PWM Specification

By connecting a capacitor to the SST pin, soft start control is performed by the start-up mode conditions during the mode transition. The period for soft start control is determined by the formula shown on the next page. When soft start control is not required, ensure to connect SST pin to VREG pin.

Below shows the correlation timing chart of count data and PWM enabled duty for VSP and SST.



•Notes on the use of the soft-start function.

With the increase in soft-start time, the motor current will also increase slowly. Therefore if the soft-start timing is too long, it will result in the motor not having enough starting torque and lock protection detection will be triggered if soft start timing is more than 0.5s (typ). This will cause the motor to be unable to start. Please evaluate and check this condition thoroughly when using this function.

Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

5. Soft Start Function and PWM Specification (Continued)

The triangle wave oscillator frequency output by SST pin is determined by the below formula. Soft Start timing is generated by comparing the VSP pin input PWM frequency and this triangle waveform frequency.



The PWM enabled duty reflected in the output, at the time elapsed T_{PASS} within the SST enabled timing is determined by the below formula:

 $\mathsf{PWM} \, \mathsf{duty} \, = \, \frac{\mathsf{T}_{\mathsf{PASS}} \, \times \, \mathsf{T}_{\mathsf{OSC}}}{\mathsf{T}_{\mathsf{SST}} \, \times \, \mathsf{T}_{\mathsf{PWM}}} \qquad \begin{array}{c} \mathsf{T}_{\mathsf{PWM}} \, : \, \mathsf{Input} \, \mathsf{PWM} \, \mathsf{cycle} \, [\mathsf{s}] \\ \mathsf{T}_{\mathsf{OSC}} \, : \, \mathsf{Oscillation} \, \mathsf{cycle} \, \mathsf{of} \, \mathsf{internal} \, \mathsf{oscillator} \\ \mathsf{40^{*}10^{-9}} \, [\mathsf{s}] \\ \mathsf{T}_{\mathsf{SST}} \, : \, \mathsf{SST} \, \mathsf{triangle} \, \mathsf{wave} \, \mathsf{oscillation} \, \mathsf{cycle} [\mathsf{s}] \\ \mathsf{T}_{\mathsf{PASS}} \, : \, \mathsf{Time} \, \mathsf{elapsed} \, [\mathsf{s}] \end{array}$

T_{PASS} at the end of the SST timing can be determined by the below formula:

$$T_{PASS} = \frac{T_{PWM} \times D \times T_{SST}}{T_{OSC}} D : Input PWM duty [%]$$

Input PWM duty during the DC input can be determined by the below formula:

$$D = \left(\frac{97}{3} \times V_{VSP} - \frac{88}{3}\right) \times 0.01 \quad \text{Under DC input, } V_{VSP} = 1V \sim 4V$$

Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

6. Forward, Reverse and Short-brake

The Relation among Hall, FR (Forward/Reverse) and Average Output Voltage



FR switch operation

F/R is not switched instantly. Once motor rotation stops, then run at reverse direction

Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

7. Protection Functions

7-1. Motor Lock Protection

When RDS=L, SFSW=L or H (Automatic reset mode)

When no signal for Hall signal input (Based on the rising or falling edge of H1H-H1L) is continued for 0.5s(SFSW=L) or 1.0s(SFSW=H) or more, motor output turns OFF (short-brake) and Motor Lock Protection starts working (RD = L), and automatically resets after 5s(SFSW=L) or 10s(SFSW=H) elapses. Motor Lock Protection is released immediately by Hall signal input (rising or falling edge of H1H-H1L), VSP signal input, FR signal switched, UVLO signal input and SLEEP signal input.



When RDS=H, SFSW=L (Latch mode)

When there is no hall signal (Based on the rising or falling edge of H1H-H1L) for more than 2.0s, motor output will be OFF (Short-brake), operation will switch and latch to RD=L protection. UVLO signal input and SLEEP signal input will immediately release the protection.



Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

7. Protection Functions

7-1. Motor Lock Protection (Continued)

When RDS=H, SFSW=H (Immediately reset mode)

When no signal for Hall signal input (Based on the rising or falling edge of H1H-H1L) is continued for 0.5s or more, Motor Lock Protection immediately resets(after 70us elapses). Motor Lock Protection is released immediately by Hall signal input (rising or falling edge of H1H-H1L), VSP signal input, FR signal switched, UVLO signal input and SLEEP signal input.



Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

7. Protection Functions

7-2. Under Voltage Lock Out (UVLO)

When VCC voltage drops to 3.55V and below, UVLO activates and motor output enters short-brake mode. When VCC voltage increases to 3.75V and above, UVLO is released.



7-3. Over Voltage Lock Out (OVLO)

When VCC voltage increases above threshold, OVLO activates and motor output enters short-brake mode. When VCC voltage drops below threshold, OVLO is released.



Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

7. Protection Functions

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7-4. Over Current Protection (CL)

When RCS voltage increases to 0.25 V and above, OCP starts working and motor output enters short-brake mode. When RCS voltage decreases to 0.25 V and below, OCP is released.



Current value for over current detection can be set by varying the RCS pin detection resistor (RCS).

Over current protection $I_{PEAK} = 0.250V \times \frac{1}{RCS}$

Eg: I_{PEAK} = To set to 1.0 A, set RCS to 0.250 Ω based on the below formula.

$$RCS = 0.250(V) \times \frac{1}{1.00(A)} = 0.250(\Omega)$$

7-5. Thermal Shut Down (TSD)

When IC junction temperature increases to 160°C and above, TSD activates and motor output turns OFF. When IC junction temperature drops to 135°C and below, TSD is released.



KA44143A DATASHEET

Note) The characteristics listed below are reference values derived from design of the IC and are not guaranteed.

8. Control mode Table

Pin	Pin		Descriptio	.n		Va	oltage		Pomarks
No.	Name		Descriptio	n	Open	(Low)	I	High	
3	SLEEP	Slee	ep mode selec	t	Normal		Ę	Sleep	SLEEP = "H" : Sleep mode (Motor energization: OFF, VREG output: OFF) SLEEP = "L" : Normal mode Note) For the setting range of SLEEP control voltage, refer to "SLEEP" under Electrical Characteristics on page 7.
14	OVS	ovi	OVP Threshold select		27	.2V		16V	Note: Please connect to VREG pin when set to High.
16	PS	Pha	ase Shift mode	select	Αι	uto	Cc	onstant	Note: Please connect to VREG pin when set to High. Note: Do not switch during motor driving.
18	SST	Cap for \$ way sett	Dacitor connect Soft Start trian /e oscillator fre ting	tion pin gle equency		-	Soft st not	art control t in use	When soft start control is not in used, please connect SST pin to VREG pin. When soft start control is in used, please connect a capacitor to SST pin.
19	TRI	Cap for I osc sett	Capacitor connection pin for PWM triangle wave oscillator frequency setting			_ PWM input _ control		'M input ontrol	When PWM input is used in speed control, please connect TRI pin to VREG pin. When DC input is used in speed control, please connect a capacitor to TRI pin.
					Voltage				
Din	Dim					Ve	oltage		
Pin No.	Pin Name		Descriptio	'n	Low	V(/ (M	oltage)pen iddle)	High	Remarks
Pin No.	Pin Name FR	Rota (Foi Sho	Descriptio	n select ∌) ol input	Low	rrd S	oltage Open liddle) Short- orake	High	Remarks Arbitrary direction is denoted as "Forward", and reverse direction is denoted as "Reverse". Note) For the setting range of FR control voltage, refer to "FR" under Electrical Characteristics on page 9.
Pin No. 22 17	Pin Name FR	Rot. (Foi Shc	Descriptio	en select e) ol input elect l cycle]	Low Forwa	V((M Ird S t	Ditage Dpen liddle) Short- brake	High Reverse	Remarks Arbitrary direction is denoted as "Forward", and reverse direction is denoted as "Reverse". Note) For the setting range of FR control voltage, refer to "FR" under Electrical Characteristics on page 9. FG pulse output which is equivalent to arbitrary magnification of hall signal cycle Note) For set range of FGSEL control voltage, refer to "FGSEL" of the Electrical Characteristics on page 9
Pin No. 22 17 Pin No 15 Pin Nam RDS	Pin Name FR FGSEL Pin No 23 Pin Na SFSW	Rot. (For Shc [rati	Descriptio	select select il cycle] Lock Detection Time [s]	Low Forwa 1/3 n Re Tin [s]	V(/ (M urd S t t t t t	Ditage Dpen liddle) Short- brake 1/2 Auto reset	High Reverse 1	Remarks Arbitrary direction is denoted as "Forward", and reverse direction is denoted as "Reverse". Note) For the setting range of FR control voltage, refer to "FR" under Electrical Characteristics on page 9. FG pulse output which is equivalent to arbitrary magnification of hall signal cycle Note) For set range of FGSEL control voltage, refer to "FGSEL" of the Electrical Characteristics on page 9 rks
Pin No. 22 17 Pin No 15 Pin Nam RDS Low	Pin Name FR FGSEL	Rot. (Foi Shc FG [rati	Descriptio	elect l cycle] Lock Detection Time [s] 0.5	Low Forwa 1/3 2n Lo Tin [s] 5	V((M (M (M k lase ne	Ditage Dpen liddle) Short- orake 1/2 Auto reset YES	High Reverse 1 Rema	Remarks Arbitrary direction is denoted as "Forward", and reverse direction is denoted as "Reverse". Note) For the setting range of FR control voltage, refer to "FR" under Electrical Characteristics on page 9. FG pulse output which is equivalent to arbitrary magnification of hall signal cycle Note) For set range of FGSEL control voltage, refer to "FGSEL" of the Electrical Characteristics on page 9 Intervention Intervention Intervention FG pulse output which is equivalent to arbitrary magnification of hall signal cycle Note) For set range of FGSEL control voltage, refer to "FGSEL" of the Electrical Characteristics on page 9 Intervention Interventio
Pin No. 22 17 Pin No 15 Pin Nam RDS Low Low	Pin Name FR FGSEL Pin Na 23 Pin Na SFSW Low High	Rot. (Foi Shc [rati	Descriptio	select elect il cycle] Lock Detection Time [s] 0.5 1.0	Low Forwa 1/3 20 Re Tin [S] 5 10	V((M) (M) (M) (M) (M) (M) (M) (M) (M) (M	Ditage Dpen liddle) Short- brake 1/2 1/2 Auto reset YES YES	High Reverse 1 Rema The S time a RDS =	Remarks Arbitrary direction is denoted as "Forward", and reverse direction is denoted as "Reverse". Note) For the setting range of FR control voltage, refer to "FR" under Electrical Characteristics on page 9. FG pulse output which is equivalent to arbitrary magnification of hall signal cycle Note) For set range of FGSEL control voltage, refer to "FGSEL" of the Electrical Characteristics on page 9 Interse tart frequency, the lock detection and the release are selectable by RDS and SFSW pin voltage. ="H", SFSW = "L": In this pattern, the lock
Pin No. 22 17 Pin No 15 Pin Nam RDS Low Low High	Pin Name FR FGSEL PGSEL Pin Na 23 Pin Na SFSW Low High Low	Rot. (Fol Shc [rati	Descriptio	select select il cycle] Lock Detection Time [s] 0.5 1.0 2.0	Low Forwa 1/3 200 Re Tin [s] 5 1(0 -	V((M (M (M (M (M (M (M (M (M (Dipen liddle) Short- brake 1/2 Auto reset YES NO	High Reverse 1 Reman	Remarks Arbitrary direction is denoted as "Forward", and reverse direction is denoted as "Reverse". Note) For the setting range of FR control voltage, refer to "FR" under Electrical Characteristics on page 9. FG pulse output which is equivalent to arbitrary magnification of hall signal cycle Note) For set range of FGSEL control voltage, refer to "FGSEL" of the Electrical Characteristics on page 9 Integration Integration Integration FG pulse output which is equivalent to arbitrary magnification of hall signal cycle Note) For set range of FGSEL control voltage, refer to "FGSEL" of the Electrical Characteristics on page 9 Integration

PIN EQUIVALENT CIRCUIT















PACKAGE INFORMATION

Outline Drawing

QFN 24L 4x4mm², Thickness 0.8mm, Lead Pitch 0.5mm,

Lead Length 0.4mm, EP Size 2.5x2.5mm



USAGE NOTES

- Below are the notes to take note when using this IC.
- 1. Pay attention to the direction of the IC. When mounting it in the wrong direction onto the PCB (printed-circuit-board), it might be damaged.
- 2. Pay attention in the PCB (printed-circuit-board) pattern layout in order to prevent damage due to short circuit between pins. In addition, refer to the Pin Description for the pin configuration.
- 3. Perform visual inspection on the PCB before applying power, otherwise damage might happen due to problems such as solder-bridge between the pins of the IC. Also, perform full technical verification on the assembly quality, because the same damage possibly can happen due to conductive substances, such as solder ball, that adhere to the IC during transportation.
- 4. Take notice in the use of this IC that it might be damaged when an abnormal state occurs such as output pin-VCC short (Power supply fault), output pin-GND short (Ground fault), or output-to-output-pin short (load short). Safety measures such as installation of fuses are recommended because the extent of the above-mentioned damage will depend on the current capability of the power supply.

Although the following pins comes with short circuit protection function, the protection may be damaged depending on the VCC voltage. Pins with short circuit protection function: Pin11(U), Pin10(V) and Pin8(W).

5. The protection circuit is for maintaining safety against abnormal operation.

When sudden voltage or current change is applied to the pin, it may exceed the designated voltage and current level and therefore, customer shall perform sufficient evaluation and verification to ensure these are not exceeded in the usage. Especially for the thermal protection circuit, if the area of safe operation or the absolute maximum rating is momentarily exceeded due to output pin to VCC short (Power supply fault), or output pin to GND short (Ground fault), the IC might be damaged before the thermal protection circuit could operate.

- 6. Unless specified in the product specifications, make sure that negative voltage or excessive voltage are not applied to the pins because the IC might be damaged, which could happen due to negative voltage or excessive voltage generated during the ON and OFF timing when the inductive load of a motor coil or actuator coils of optical pick-up is being driven.
- 7. Product which has specified ASO (Area of Safe Operation) should be operated in ASO
- 8. Verify the risks which might be caused by the malfunctions of external components.
- 9. Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process
- 10. Dip soldering is not recommended.
- 11. Connect the metallic plate (fin) on the back side of the IC to the GND potential. The thermal resistance and electrical characteristics are guaranteed only when the metallic plate (fin) is connected with the GND potential.
- 12. Follow the power supply voltage, load and ambient temperature conditions to ensure that there is enough margin and the thermal design does not exceed the allowable value.
- 13. When designing your equipment, comply with the range of absolute maximum rating and the guaranteed operating conditions (operating power supply voltage and operating environment, etc.). Especially, please be careful not to exceed the range of absolute maximum rating on the transient state, such as power-on, power-off and mode switching. Otherwise, we will not be liable for any defect which may arise later in your equipment.

Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damage, for example, by using the products.

USAGE NOTES (Continued)

14. Apply power supply with low impedance to VCC and connect bypass capacitor near to the IC. value for over current protection may fluctuate due to the impedance of wiring pattern between RCS pin and the RCS resistor. 18. In the 1-HALL-sensor system motor driver adopted in this IC, energization pattern of a cycle is generated based on previous When the above acceleration problems arises, the problem may be improved by putting the speed to zero first and then input (When HALL input signal of below 10Hz is inputted to this IC, putting the speed to zero and then input the required speed 20. Brake current during short brake is determined by the motor running speed and motor characteristics. 24. For the below pins, please ensure to connect to VREG pin under High level condition.

- Below are the notes to take note when using this IC. (Continued)

 - 15. When designing PCB pattern for RCS pin (Pin 9), place a resistor for current detection (R_{RCS}) close to the IC. The setting
 - 16. When VCC is input, VCC voltage will start to rise to the designated voltage. However, at the same time, motor driver starts driving and when this results in decreases the VCC voltage, it may disrupt the normal start-up. Therefore, please conduct sufficient evaluation and verification to ensure the power supply current.
 - 17. The minimum input amplitude of hall signal comparator should be designed in consideration of tolerances and temperature characteristics of the hall element, so that it will not result in failure to the motor operation.
 - 1-cycle of a HALL input signal. Therefore, when the acceleration of a motor is very high, the motor may be unable to accelerate normally because of the big difference in cycle between the generated energization pattern and the motor rotation. When using a motor with very high speed acceleration, ensure to conduct sufficient technical evaluation and examination on the sudden acceleration from low rotation.

the required speed. Please conduct sufficient evaluation before use.

again will restart the rotation.)

- 19. Do not change the control signal of SLEEP pin (pin 3) from Low to High while motor is running at high speed. The IC can be damaged due to the effect of induced voltage and conduction angle. Conduct sufficient technical evaluation to verify.
- Before the short brake, please review and evaluate by reducing the motor current and lower the motor speed. Please refer to the ASO data and perform sufficient evaluation to ensure that the IC is not damaged.
- 21. In case the motor running speed changes from high to low rapidly, supply voltage can be increased due to the flow back of motor current. Conduct sufficient evaluation and examination to ensure there is no issue.
- 22. When designing PCB pattern, place a resistor for current detection (RCS) close to the IC. The setting value for over current protection may fluctuate due to the impedance of wiring pattern between RCS pin and the RCS resistor.
- 23. FG pin (Pin 1) and RD pin (Pin 2) are open-drain outputs. Connect a pull-up resistor to the designated power supplies and use this IC within the allowable voltage and current ranges.
- TRI pin (Under PWM control), SST pin (When Soft Start not used), FGSEL pin, PS pin, RDS pin, OVS pin and SFSW pin. In addition, these terminals, changing the applied voltage during the operation of this product, we do not assume. When changing the voltage applied to the terminal settings, please temporarily turn off the power.
- 25. When connecting TRI pin to VREG pin using PWM input mode, please make sure to input High level or Low level to the VSP pin. Other voltage levels between High and Low level may result in unexpected operation.
- 26. Due to the initial position of the rotor, the starting torque differs slightly during start-up. For motor type that requires large inertia force to turn, please ensure that sufficient starting current is available for the motor. Please perform sufficient testing and evaluations to ensure this.
- 27. If the soft-start timing is too long, it will result in the motor not having enough starting torque and lock protection detection will be triggered if soft start timing is more than 0.5s (typ). This will cause the motor to be unable to start. Please evaluate and check this condition thoroughly when using this function.
- 28. Sufficiently check the characteristics before use. When there is changes in the external circuits, please check both static and transient characteristics and ensure that there is enough margin.

USAGE NOTES (Continued)

• Below are the notes to take note when using this IC. (Continued)

29. When input power to VCC(Pin7), it is recommended that VCC voltage rises slower than 1.5V/µs and when turn off, VCC voltage drops slower than -1.5V/us. When performing power up and shutdown at high-speed, please ensure sufficient evaluation is performed to verify that there is no problem. 30. Capacitor between VCC and GND This IC employs the PWM driving method and hence, output transistor switches under high current condition and this easily generates noise. Therefore the IC may be damaged or malfunction due to noise. Hence, it is necessary to ensure that the power supply is stable so as to avoid circuit damaged or malfunction due to noise. Where possible, place a capacitor between VCC and GND near to the IC so that IC will not malfunction due to PWM noise and gets damaged. 31. Points to note for Motor PCB pattern As this IC is used under high current, it is necessary to take note of common impedance in the pattern. Please take care of the following in the pattern design of the motor PCB. As high current flows from VCC connector to the IC VCC pin (Pin7) and through the metal lines, if the metal line is a 'L' shape pattern, noise may be easily generated resulting in malfunction and damage during switching (Bottom left figure). From the figure on the right, if a capacitor is placed with respect to the connector near VCC, a noise discharge route is created and this reduces the VCC voltage directly to the IC pin. Where possible, please follow the figure on the right. In addition, metal line impedance depends on the pattern length and therefore, please keep the metal line between VCC connector and IC VCC pin as short and as thick as possible in the design. The line between current detection resistor (R_{RCS}) to RCS pin (Pin9) is very important. Therefore, where possible, it is recommended to use an isolated line to connect from the start of the detection resistor to the RCS pin. Accurate current value may not be detected due to metal impedance if R_{RCS} is placed far from the IC. Therefore, if it is not possible to place near to the IC, please ensure that the motor current waveform and R_{RCS} current waveform is accurate. Please ensure that the line between the GND connector and RCS resistor is isolated from the IC GND pin (Pin5). If a common line is used, it may result in malfunction or IC ground connection voltage unstable due to line impedance. In addition, to reduce line impedance effect, please ensure that GND line is as short and as thick as possible in the design. Noise easily generated Recommended PCB Capacitor between VM-GND reduces spike. M VCC (111) GND GND L Š IC IC С S RCS¹ ř R_{RCS} $\mathsf{R}_{\mathsf{RCS}}$ GND

USAGE NOTES (Continued)

• Below are the notes to take note when using this IC. (Continued)

32. This IC has five protecting functions. Pay attention to the descriptions below.							
Function	Operate/Release	Conditions	Remarks				
Under voltage lock out (UVLO)	 Operate VCC ≤ 3.55 V Release VCC ≥ 3.75 V 	(Short brake) Upper-phase: OFF Lower-phase: ON	Large current may be generated due to a short brake during motor rotation. Conduct sufficient verification to prevent damages.				
Over voltage lock out (OVLO)	 Operate/Release VCC input voltage1: 16.0V (typ.) VCC input voltage2: 27.2V (typ.) 	(Short brake) Upper-phase: OFF Lower-phase: ON	Large current may be generated due to a short brake during motor rotation. Conduct sufficient verification to prevent damages.				
Over Current Protection (CL)	 Operate: RCSS voltage ≥ 0.25V (typ.) Release: RCSS voltage ≤ 0.25V (typ.) 	(Short brake) Upper-phase: OFF Lower-phase: ON	R_{RCS} is a current detection resistor. Concerning level of detection, false detection may occur due to the effect of PCB layout or noise. In addition, when specifying the resistance value of R_{RCS} , take the followings into consideration: Level of detection, tolerance in resistance value of R_{RCS} , temperature, ratings, etc.				
Motor Lock Protection	 Operate: Hall signal input cycle ≥ 0.5 s (RDS=L, SFSW=L) (RDS=H, SFSW=H) ≥ 1.0 s (RDS=L, SFSW=H) ≥ 2.0 s (RDS=H, SFSW=L) (Based on the rising or falling edge of H1H-H1L) Release: With RDS and SFSW is set to following voltage, any of the below 7 conditions will result in the protection to release. RDS = L or open and SFSW = L or H RDS = L or open and SFSW = L or H RDS = H and SFSW = H SLEEP is input with 'H' 2UVLO operates (VCC<3.55V) Automatic reset after the following time; 5 s (RDS=L, SFSW=L) 10 s (RDS=L, SFSW=H) 70 us (RDS=H, SFSW=H) 4 Hall signal being input (Rising or falling edge of H1H-H1L) VSP(PWM)<3.0%(typ), or VSP(DC)<1.0V(typ) is inputted FR signal switch is inputted Control restrictions to protection functions When RDS is set to 'H' and SFSW is set to 'L', the above ③~⑦ will be disabled. 	(Short brake) Upper-phase: OFF Lower-phase: ON	Brake current may be generated due to protection circuit operating during the motor rotation. Conduct sufficient verification to prevent damages.				
Thermal Protection	 Operate: IC junction temperature > 160°C Release: IC junction temperature < 135°C 	All phases: OFF	Since all phases are OFF when protecting function operates, reverse current may be generated due to the repetition ON-OFF switching of the protection function during motor rotation. Pay attention to the voltage rise.				

Revision History

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Date	Revision	De	escription	
2020.10.31	1.00	1	Initially issued.	
2022.6.9	1.05	1	Changed important notice	Page2
		2	Operating ambient temperature max " 95□C"-> " 105□C"	Page5
		3	POWER DISSIPATION RATING	
			PD(Ta=70□C) 1.42W -> PD(Ta=105□C) 0.8W	
		4	Remove important notice page from previous version page46,47	Page47,
				48,49
		5	Changed the description of usage notes	Page48
			Add "(Continued)"	
		6	Change page number to refer because of adding page 2	Page6,23,35
				Page42
		7	Change pin names. "N1H", "N1L" -> "H1H", "H1L"	
2023.8.31	1.06	1	Changed power dissipation rating notice	Page5
		2	Changed block diagram composition	Page12
		3	Changed pin equivalent circuit composition	Page37-43
		4	Deleted some Package information	Page44-45

Important Notice

Nuvoton Products are neither intended nor warranted for usage in systems or equipment, any malfunction or failure of which may cause loss of human life, bodily injury or severe property damage. Such applications are deemed, "Insecure Usage".

Insecure usage includes, but is not limited to: equipment for surgical implementation, atomic energy control instruments, airplane or spaceship instruments, the control or operation of dynamic, brake or safety systems designed for vehicular use, traffic signal instruments, all types of safety devices, and other applications intended to support or sustain life.

All Insecure Usage shall be made at customer's risk, and in the event that third parties lay claims to Nuvoton as a result of customer's Insecure Usage, customer shall indemnify the damages and liabilities thus incurred by Nuvoton.

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